



1.6 x 0.8mm Surface Mount Ambient Light Sensor

Technical Data Sheet

Features

Package (L/W/H) : 1.6 $\, imes \,$ 0.8 $\, imes \,$ 0.8mm

Chip Material : Silicon

Lens: Water Clear

Fast response time

High photo sensitivity

Close responsively to the human eye spectrum

Consist of phototransistor in miniature SMD

Device Selection Guide

| | Chip | Lens Color | |
|---------------------|----------|-------------|--|
| LED Part No. | Material | | |
| 0603080-FLWC-ALS-PT | Silicon | Water clear | |

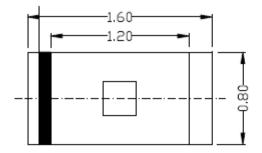


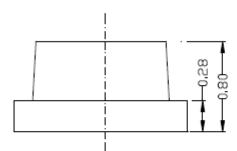


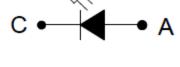
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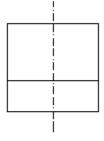
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Package Dimensions

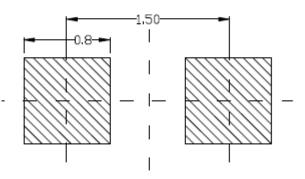








Soldering PAD Suggested:



- All dimensions are millimeters.
- ✤ Tolerance is 0.1mm unless otherwise noted.





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Electro-Optical Characteristics (T₂=25℃)

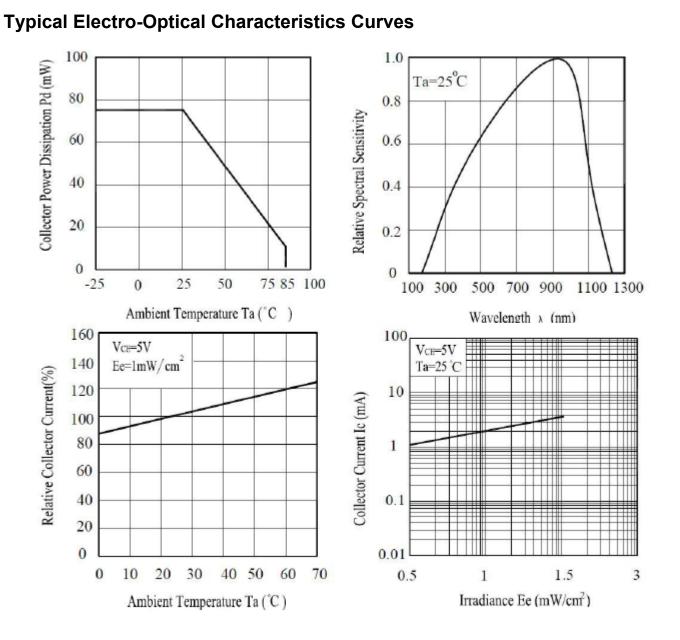
| Parameter | Symbol | MIN. | TYP. | MAX. | UNIT | TEST CONDITION |
|--|--------------------|------|------|------|------|---|
| Collector dark current | ICEO | | | 100 | nA | V _{CE} =20V H=0mW/cm ² |
| C-E Saturation Voltage | VCE (Sat) | | 0.2 | 0.4 | v | Ic=2mA IB=100uA |
| Collector-Emitter Breakdown Voltage | BV _{CEO} | 30 | | | v | I _C =100uA Ee=0mW/cm ² |
| Emitter-Collector Breakdown Voltage | BV _{ECO} | 5 | | | v | $I_E=100uA$ Ee=0mW/cm ² |
| Rise Time(10%to90%) | tr | | 15 | | uS | V _{CE} =5V Ic=1mA R _L =100ohms |
| Fail Time(90% to10%) | tf | | 15 | | | |
| Wavelength of Peak Sensitivity | λр | | 940 | | nm | |
| Range of Spectral Bandwidth | λ0.5 | 550 | | 1100 | nm | |
| On State Collector Current | I _{C(ON)} | 0.3 | 0.6 | | mA | V _{CE} =5V Ee=1mW/cm ² |





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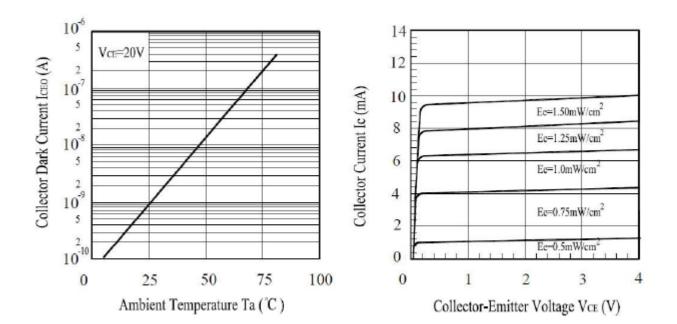




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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big Current change (Burn out will happen)

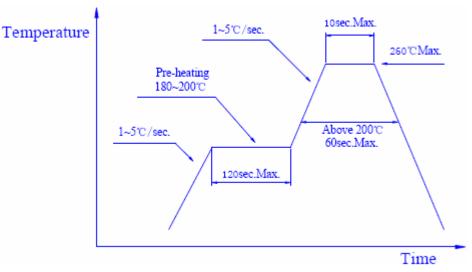
2. Storage

Do not open moisture proof bag before the products are ready to use Before opening the package, the LEDs should be kept at 30°C or less and 90% RH or less The LEDs should be used within a year After opening the package, the LEDs should be kept at 30°C or less 70% RH or less The LEDs should be used within 168 hours(7 days)after opening the package If the moisture absorbent material(silica gel)has faded away or the LEDs have exceeded the

Storage time, baking treatment should be performed using the following conditions Baking treatment:60±5°C for 24 hours

3. Soldering Condition

Pb-free solder temperature profile



Reflow soldering should not be done more than two times When soldering, do not put stress on the LEDs during heating After soldering, do not warp the circuit board

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals,

and do

soldering of each terminal. Be careful because the damage of the product is often started at the





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time of

the hand solder

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether

the characteristics of the LEDs will or will not be damaged by repairing

